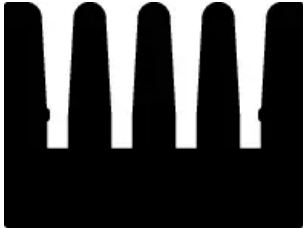


Data sheet Product ICK SMD F 8 MI



Heatsinks and active heatsinks for processors>Heatsinks for DIL-IC, PLCC and SMD

8 x 6 mm, for SMD components and others

Features

width:	8 mm
height:	6 mm
plate thickness:	2 mm
length:	8 mm
thermal resistance:	74 K/W
surface:	solderable surface
packing:	tape and reel

Technical Drawing

